

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









APPROVAL SHEET

RFBPF Series – 3225(1210)- RoHS Compliance

MULTILAYER CERAMIC BAND PASS FILTER

Halogens Free Product

475~675 MHz Band Application

P/N: RFBPF3225200Y07B1U

*Contents in this sheet are subject to change without prior notice.

FEATURES

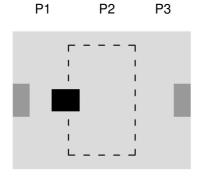
- 1. Miniature footprint: 3.2 X 2.5 X 2.0 mm³
- 2. Low Insertion Loss
- 3. High Rejection
- 4. LTCC process

APPLICATIONS

- 1. 475 ~ 675 MHz Band application
- 2. For MoCA application

CONSTRUCTION

Top view



PIN	Connection		
1	Input port		
2	GND		
3	Output port		

DIMENSIONS

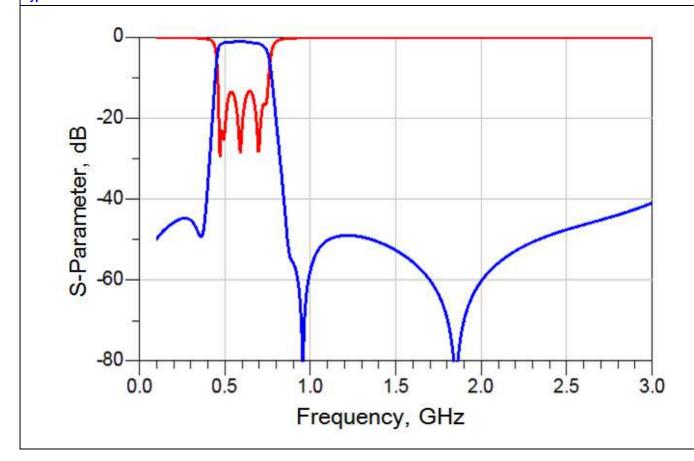
Figure	Symbol	Dimension (mm)
	L	3.20 ± 0.20
L L	W	2.50 ± 0.20
Top view ≥ ■ ■	Т	2.00 max.
Side view	А	0.95 ± 0.20
	В	0.60 ± 0.20
C D E T	С	0.30 ± 0.15
Bottom view	D	0.70 ± 0.15
	E	1.20 ± 0.15
	F	2.00 ± 0.15



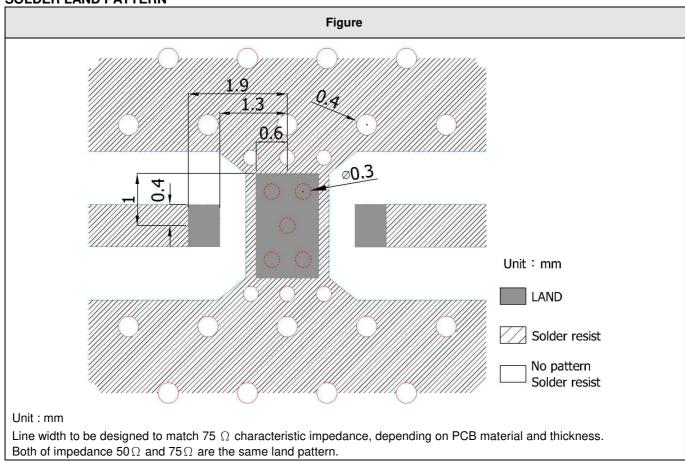
ELECTRICAL CHARACTERISTICS

475 ~ 675 MHz 2.50 dB max. at +25°C 2.70 dB max. at -40°C ~ +85°C
2.70 dB max. at -40°C ~ +85°C
2.00 max
75 Ω
60 dB @ 2.5 MHz
40 dB @ 2.5 ~ 100 MHz
35 dB @ 100 ~ 200 MHz
35 dB @ 200 ~ 300 MHz
8 dB @ 300 ~ 400 MHz
57 dB @ 950 MHz
47 dB @ 950 ~ 2025 MHz
41 dB @ 2025 ~ 2500 MHz
35 dB @ 2500 ~ 3000 MHz
-40°C ~ +85°C

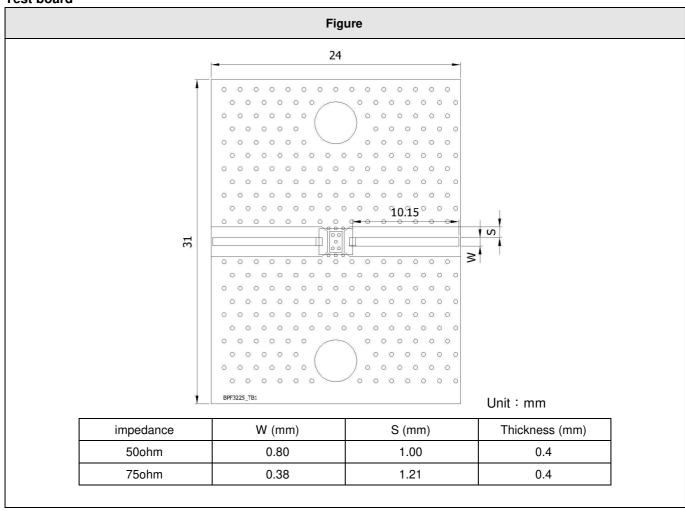
Typical Electrical Chart



SOLDER LAND PATTERN



Test board





RELIABILITY TEST

Test item	Test condition / Test method	Specification
Solderability	*Solder bath temperature : $235 \pm 5^{\circ}$ C	At least 95% of a surface of each terminal
JIS C 0050-4.6	*Immersion time : 2 ± 0.5 sec	electrode must be covered by fresh solder.
JESD22-B102D	Solder : Sn3Ag0.5Cu for lead-free	
Leaching	*Solder bath temperature : 260 ± 5°C	Loss of metallization on the edges of each
(Resistance to	*Leaching immersion time : 30 ± 0.5 sec	electrode shall not exceed 25%.
dissolution of	Solder : SN63A	ciodi dde Shaii Hot exeecd 2576.
metallization)		
IEC 60068-2-58		
Resistance to soldering heat	*Preheating temperature : $120~150^{\circ}$ C,	No mechanical damage.
JIS C 0050-5.4	1 minute.	Electrical specification shall satisfy the
	*Solder temperature: 270±5°C	descriptions in electrical characteristics under
	*Immersion time: 10±1 sec	the operational temperature range within -40
		~ 85℃.
	Solder : Sn3Ag0.5Cu for lead-free	Loss of metallization on the edges of each
	Measurement to be made after keeping at	electrode shall not exceed 25%.
	room temperature for 24±2 hrs	Cloud Gridin Hot Cx0000 2070.
Drop Test JIS C 0044	*Height: 75 cm	No mechanical damage.
Customer's specification.	*Test Surface: Rigid surface of concrete or	Electrical specification shall satisfy the
Castomer & specification.	steel.	descriptions in electrical characteristics under
	*Times: 6 surfaces for each units; 2 times	the operational temperature range within -40
	for each side.	~ 85℃.
Vibration	*Frequency: 10Hz~55Hz~10Hz(1min)	No mechanical damage.
JIS C 0040	*Total amplitude: 1.5mm	Electrical specification shall satisfy the
	*Test times : 6hrs.(Two hrs each in three	descriptions in electrical characteristics under
	mutually perpendicular directions)	the operational temperature range within -40
		~ 85℃.
Adhaniya Ctronath		
Adhesive Strength of Termination	*Pressurizing force :	No remarkable damage or removal of the
	5N(≦0603) ; 10N(>0603)	termination.
JIS C 0051- 7.4.3	*Test time: 10±1 sec	
Bending test	The middle part of substrate shall be	No mechanical damage.
JIS C 0051- 7.4.1	pressurized by means of the pressurizing rod	Electrical specification shall satisfy the
	at a rate of about 1 mm/s per second until the	descriptions in electrical characteristics under
	deflection becomes 1mm/s and then pressure	the operational temperature range within -40
	shall be maintained for 5±1 sec.	~ 85℃.
	Measurement to be made after keeping at	
	room temperature for 24±2 hours	

Approval slicet		, , , , , , , , , , , , , , , , , , ,
Temperature cycle JIS C 0025	 30±3 minutes at -40°C±3°C, 10~15 minutes at room temperature, 30±3 minutes at +85°C±3°C, 10~15 minutes at room temperature, Total 100 continuous cycles Measurement to be made after keeping at room temperature for 24±2 hrs 	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85℃.
High temperature JIS C 0021 Humidity (steady conditions) JIS C 0022	*Temperature: 85°C±2°C *Test duration: 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs *Humidity: 90% to 95% R.H. *Temperature: 40±2°C *Time: 1000+24/-0 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C. No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under
Low temperature JIS C 0020	Measurement to be made after keeping at room temperature for 24±2 hrs 300 state 500 s	the operational temperature range within -40 ~ 85°C. No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40
	Toom temperature for ETTE file	~ 85℃.

SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2,

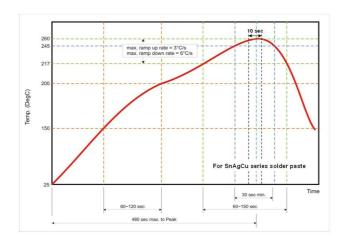


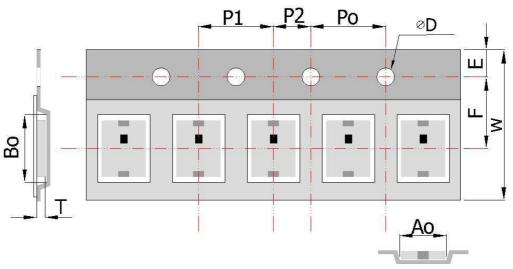
Fig 2. Infrared soldering profile

ORDERING CODE

RF	BPF	322520	0	Υ	07B1U
Walsin	Product Code	Dimension code	Unit of	Application	Specification
RF device	BPF:	Per 2 digits of Length,	dimension	Y: DVB 465-	Design code
	Band Pass Filter	Width, Thickness:	0 : 0.1 mm	862MHz/475~675M	
		e.g. :	1 : 1.0 mm	Hz/703~803MHz	
		322520 =			
		Length 32,			
		Width 25,			
		Thickness 20			

Minimum Ordering Quantity: 2000 pcs per reel.

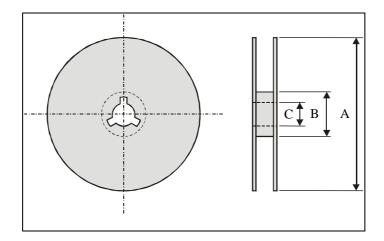
PACKAGING



Plastic Tape specifications (unit :mm)

Index	Ao	Во	ΦD	Т	W
Dimension (mm)	2.72 ± 0.10	3.606 ± 0.10	1.55 + 0.10	2.10 ± 0.10	8.0 ± 0.10
Index	E	F	Po	P1	P2
Dimension (mm)	1.75 ± 0.10	3.50 ± 0.05	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.10

Reel dimensions



Index	Α	В	С
Dimension (mm)	Φ178.0	Φ60.0	Ф13.0

Taping Quantity: 2000 pieces per 7" reel

CAUTION OF HANDLING

Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

Storage condition

- Products should be used in 6 months from the day of WALSIN outgoing inspection, which can be confirmed.
- (2) Storage environment condition.
 - Products should be storage in the warehouse on the following conditions.

■ Temperature : -10 to +40°C

Humidity: 30 to 70% relative humidity

- Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
- Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be storage under the airtight packaged condition.